## NPN / PNP Silicon Switching Transistor Array

- High current gain
- Low collector-emitter saturation voltage
- Two (galvanic) internal isolated NPN / PNP transistor in one package
- Pb-free (RoHS compliant) package
- Qualified according AEC Q101



## SMBT3904PN

SMBT3904UPN


| Type | Marking |  |  |  |  |  | Pin Configuration |  |  |  |  | Package |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :---: | :---: | :---: | :---: |
| SMBT3904PN | s3P | $1=\mathrm{E}$ | $2=\mathrm{B}$ | $3=\mathrm{C}$ | $4=\mathrm{E}$ | $5=\mathrm{B}$ | $6=\mathrm{C}$ | SOT363 |  |  |  |  |
| SMBT3904UPN | s 3 P | $1=\mathrm{E}$ | $2=\mathrm{B}$ | $3=\mathrm{C}$ | $4=\mathrm{E}$ | $5=\mathrm{B}$ | $6=\mathrm{C}$ | SC74 |  |  |  |  |

## Maximum Ratings

| Parameter | Symbol | Value | Unit |
| :--- | :--- | :---: | :--- |
| Collector-emitter voltage | $V_{\mathrm{CEO}}$ | 40 | V |
| Collector-base voltage | $V_{\mathrm{CBO}}$ | 40 |  |
| Emitter-base voltage | $V_{\text {EBO }}$ | 6 |  |
| Collector current | $I_{\mathrm{C}}$ | 200 | mA |
| Total power dissipation- | $P_{\text {tot }}$ |  | mW |
| $T_{\text {S }} \leq 115^{\circ} \mathrm{C}$, SMBT3904PN |  | 250 |  |
| $T_{\text {S }} \leq 105^{\circ} \mathrm{C}$, SMBT3904UPN |  | 330 |  |
| Junction temperature | $T_{\mathrm{j}}$ | 150 | ${ }^{\circ} \mathrm{C}$ |
| Storage temperature | $T_{\text {stg }}$ | $-65 \ldots 150$ |  |


| Thermal Resistance |  |  |  |
| :--- | :--- | :--- | :--- |
| Parameter | Symbol | Value | Unit |
| Junction - soldering point ${ }^{1)}$ | $R_{\text {thJS }}$ |  | K/W |
| SMBT3904PN |  | $\leq 140$ |  |
| SMBT3904UPN |  | $\leq 135$ |  |

Electrical Characteristics at $T_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise specified

| Parameter | Symbol | Values |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | min. | typ. | max. |  |
| DC Characteristics |  |  |  |  |  |
| Collector-emitter breakdown voltage $I_{\mathrm{C}}=1 \mathrm{~mA}, I_{\mathrm{B}}=0$ | $V_{\text {(BR)CEO }}$ | 40 | - | - | V |
| Collector-base breakdown voltage $I_{\mathrm{C}}=10 \mu \mathrm{~A}, I_{\mathrm{E}}=0$ | $V_{(\mathrm{BR}) \mathrm{CBO}}$ | 40 | - | - |  |
| Emitter-base breakdown voltage $I_{E}=10 \mu \mathrm{~A}, I_{\mathrm{C}}=0$ | $V_{(\mathrm{BR}) \mathrm{EBO}}$ | 6 | - | - |  |
| Collector-base cutoff current $V_{\mathrm{CB}}=30 \mathrm{~V}, I_{\mathrm{E}}=0$ | $I_{\text {CBO }}$ | - | - | 50 | nA |
| DC current gain ${ }^{2)}$ $\begin{aligned} & I_{\mathrm{C}}=100 \mu \mathrm{~A}, V_{\mathrm{CE}}=1 \mathrm{~V} \\ & I_{\mathrm{C}}=1 \mathrm{~mA}, V_{\mathrm{CE}}=1 \mathrm{~V} \\ & I_{\mathrm{C}}=10 \mathrm{~mA}, V_{\mathrm{CE}}=1 \mathrm{~V} \\ & I_{\mathrm{C}}=50 \mathrm{~mA}, V_{\mathrm{CE}}=1 \mathrm{~V} \\ & I_{\mathrm{C}}=100 \mathrm{~mA}, V_{\mathrm{CE}}=1 \mathrm{~V} \end{aligned}$ | $h_{\text {FE }}$ | $\begin{gathered} 40 \\ 70 \\ 100 \\ 60 \\ 30 \end{gathered}$ |  | $300$ | - |
| Collector-emitter saturation voltage ${ }^{2}$ ) $\begin{aligned} & I_{\mathrm{C}}=10 \mathrm{~mA}, I_{\mathrm{B}}=1 \mathrm{~mA} \\ & I_{\mathrm{C}}=50 \mathrm{~mA}, I_{\mathrm{B}}=5 \mathrm{~mA} \end{aligned}$ | $V_{\text {CEsat }}$ | - |  | $\begin{gathered} 0.25 \\ 0.4 \end{gathered}$ | V |
| Base emitter saturation voltage ${ }^{2)}$ $\begin{aligned} & I_{\mathrm{C}}=10 \mathrm{~mA}, I_{\mathrm{B}}=1 \mathrm{~mA} \\ & I_{\mathrm{C}}=50 \mathrm{~mA}, I_{\mathrm{B}}=5 \mathrm{~mA} \end{aligned}$ | $V_{\text {BEsat }}$ | $0.65$ | - | $\begin{aligned} & 0.85 \\ & 0.95 \end{aligned}$ |  |

[^0]SMBT3904...PN

Electrical Characteristics at $T_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise specified

| Parameter | Symbol | Values |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | min. | typ. | max. |  |
| AC Characteristics |  |  |  |  |  |
| Transition frequency $I_{\mathrm{C}}=10 \mathrm{~mA}, V_{\mathrm{CE}}=5 \mathrm{~V}, f=100 \mathrm{MHz}$ | $f_{\top}$ | 250 | - | - | MHz |
| Collector-base capacitance $V_{\mathrm{CB}}=10 \mathrm{~V}, f=1 \mathrm{MHz}$ | $C_{c b}$ | - | - | 3.5 | pF |
| Emitter-base capacitance $V_{\mathrm{EB}}=0.5 \mathrm{~V}, f=1 \mathrm{MHz}$ | $C_{\text {eb }}$ | - | - | 10 |  |
| Delay time $\begin{aligned} & V_{\mathrm{CC}}=3 \mathrm{~V}, I_{\mathrm{C}}=10 \mathrm{~mA}, I_{\mathrm{B} 1}=1 \mathrm{~mA}, \\ & V_{\mathrm{BE}(\text { (off })}=0.5 \mathrm{~V} \end{aligned}$ | $t_{\mathrm{d}}$ | - | - | 35 | ns |
| Rise time $\begin{aligned} & V_{\mathrm{CC}}=3 \mathrm{~V}, I_{\mathrm{C}}=10 \mathrm{~mA}, I_{\mathrm{B} 1}=1 \mathrm{~mA}, \\ & V_{\mathrm{BE}(\text { off })}=0.5 \mathrm{~V} \end{aligned}$ | $t_{r}$ | - | - | 35 |  |
| Storage time $V_{\mathrm{CC}}=3 \mathrm{~V}, I_{\mathrm{C}}=10 \mathrm{~mA}, I_{\mathrm{B} 1}=I_{\mathrm{B} 2}=1 \mathrm{~mA}$ | $t_{\text {stg }}$ | - | - | 225 |  |
| Fall time $V_{\mathrm{CC}}=3 \mathrm{~V}, I_{\mathrm{C}}=10 \mathrm{~mA}, I_{\mathrm{B} 1}=I_{\mathrm{B} 2}=1 \mathrm{~mA}$ | $t_{\mathrm{f}}$ | - | - | 75 |  |
| Noise figure $\begin{aligned} & I_{\mathrm{C}}=100 \mu \mathrm{~A}, V_{\mathrm{CE}}=5 \mathrm{~V}, f=1 \mathrm{kHz}, \\ & \Delta f=200 \mathrm{~Hz}, R_{\mathrm{S}}=1 \mathrm{k} \Omega \end{aligned}$ | F | - | - | 5 | dB |

DC current gain $h_{\text {FE }}=f\left(I_{C}\right)$
$V_{C E}=1 \mathrm{~V}$, normalized


Total power dissipation $P_{\text {tot }}=f\left(T_{\mathrm{S}}\right)$ SMBT3904PN


Saturation voltage $I_{\mathrm{C}}=f\left(V_{\mathrm{BEsat}} ; V_{\mathrm{CEsat}}\right)$
$h_{\text {FE }}=10$


Total power dissipation $P_{\text {tot }}=f\left(T_{\mathrm{S}}\right)$ SMBT3904UPN


Permissible Pulse Load $R_{\text {thJS }}=f\left(t_{\mathrm{p}}\right)$ SMBT3904PN


Permissible Puls Load $R_{\text {thJS }}=f\left(t_{\mathrm{p}}\right)$ SMBT3904UPN


Permissible Pulse Load
$P_{\text {totmax }} / P_{\text {totDC }}=f\left(t_{\mathrm{p}}\right)$
SMBT3904PN


Permissible Pulse Load
$P_{\text {totmax }} / P_{\text {totDC }}=f\left(t_{\mathrm{p}}\right)$
SMBT3904UPN


Delay time $t_{\mathrm{d}}=f\left(I_{\mathrm{C}}\right)$
Rise time $t_{\mathrm{r}}=f\left(I_{\mathrm{C}}\right)$


Fall time $t_{\mathrm{f}}=f\left(l_{\mathrm{C}}\right)$


Storage time $t_{\mathrm{stg}}=f\left(I_{\mathrm{C}}\right)$


Rise time $t_{\mathrm{r}}=f\left(I_{\mathrm{C}}\right)$


## Package Outline



Foot Print


## Marking Layout (Example)

Small variations in positioning of
Date code, Type code and Manufacture are possible.


## Standard Packing

Reel $\varnothing 180 \mathrm{~mm}=3.000$ Pieces/Reel
Reel $\varnothing 330 \mathrm{~mm}=10.000$ Pieces/Reel
For symmetric types no defined Pin 1 orientation in reel.


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[^0]:    ${ }^{1}$ For calculation of $R_{\text {thJA }}$ please refer to Application Note AN077 (Thermal Resistance Calculation)
    ${ }^{2}$ Pulse test: $\mathrm{t}<300 \mu \mathrm{~s}$; $\mathrm{D}<2 \%$

